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In the Claims:

1. (Original) An integrated circuit comprising:

a substrate;

a first insulating layer on the substrate that includes therein a first hole passing therethrough that includes a floor adjacent the substrate and a sidewall;

a first conductive contact that extends conformally on the sidewall and floor to define a groove in the first hole;

a second insulating layer on the first insulating layer remote from the substrate that includes therein a second hole passing therethrough that exposes the groove; and a second conductive contact in the second hole and in the groove.

- 2. (Original) An integrated circuit according to Claim 1 wherein the floor is directly on the substrate.
- 3. (Original) An integrated circuit according to Claim 1 wherein the second conductive contact fills the second hole and the groove.
- 4. (Original) An integrated circuit according to Claim 1 wherein the first conductive contact comprises a first barrier layer on the sidewall and floor and a first conductive layer on the first barrier layer remote from the sidewall and floor and wherein the second conductive contact comprises a second barrier layer on the first conductive layer and a second conductive layer on the second barrier layer remote from the first conductive layer.
- 5. (Original) An integrated circuit according to Claim 4 wherein the first and second barrier layers comprise titanium and/or titanium nitride and wherein the first and second conductive layers comprise tungsten.
- 6. (Original) An integrated circuit according to Claim 1 wherein the first conductive contact also extends onto the first insulating layer outside the first hole.
- 7. (Original) An integrated circuit according to Claim 1 wherein the second conductive contact also extends onto the second insulating layer outside the second hole.

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8. (Original) An integrated circuit according to Claim 1:

wherein the first insulating layer includes a third hole and a fourth hole passing therethrough; and

wherein the second insulating layer includes a fifth hole passing therethrough that exposes the fourth hole;

the integrated circuit further comprising:

- a third conductive contact in the third hole; and
- a fourth conductive contact in the fourth and fifth holes.
- 9. (Original) An integrated circuit according to Claim 8 further comprising: a third insulating layer on the second insulating layer remote from the first insulating layer that includes therein a sixth hole that exposes the second hole;

the second conductive contact further extending into the sixth hole.

- 10. (Original) An integrated circuit according to Claim 8 further comprising: a capacitor on the second insulating layer that is electrically connected to the fourth conductive contact.
- 11. (Original) An integrated circuit according to Claim 9 wherein the second conductive contact also extends onto the third insulating layer outside the sixth hole.
- 12. (Original) An integrated circuit according to Claim 8 wherein the first hole is at least twice as wide as the third hole.
 - 13.-26. (Canceled)
- 27. (Original) An integrated circuit according to Claim 4 wherein the first insulating layer includes a third contact hole and a fourth contact hole passing therethrough; and

wherein the second insulating layer includes a fifth hole passing therethrough that exposes the fourth hole;

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the integrated circuit further comprising:

- a third conductive contact in the third contact hole; and
- a fourth conductive contact in the fourth and fifth holes.
- 28. (Original) An integrated circuit according to Claim 7 wherein the third conductive contact comprises a third barrier layer that extends conformally inside the third contact hole and a third conductive layer on the third barrier layer.
- 29. (Original) An integrated circuit according to Claim 27 wherein the third conductive contact also extends onto the first insulating layer outside the third contact hole.
- 30. (Original) An integrated circuit according to Claim 27 wherein the first hole is at least twice as wide as the first conductive contact.